

Silicon Carbide Schottky Diode 1200 V, 20 A, 92 nC

General Description

This product family is CRM's second generation SiC JBS, with lower VF and offers state of the art performance. It is designed for high frequency applications where high efficiency and high reliability are required. It is qualified and manufactured on the productive 6 inch SiC line in China fully owned by CR MICRO.

Features

- \bullet Low conduction loss due to low $V_{\rm F}$
- \bullet Extremely low switching loss by tiny Q_C
- Highly rugged due to better surge current
- Industrial standard quality and reliability

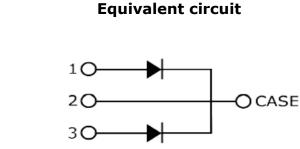
Applications

- Solar inverter
- EV charge
- High performance SMPS
- Power factor correction



| V _{RRM} | 1200 V |
|--|--------|
| I _F (T _C =159℃) | 20 A |
| Q _C | 92 nC |





Package Marking and Ordering Information

TO-247

| Part # | Marking | Package |
|--------------|--------------|---------|
| CRXQ20D120G2 | CRXQ20D120G2 | TO-247 |





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| Parameter | Symbol | Value | Unit |
|---|---------------------|-------------------------|------------------|
| Repetitive Peak Reverse Voltage | V _{RRM} | 1200 | V |
| Surge Peak Reverse Voltage | V _{RSM} | 1200 | V |
| DC Peak Reverse Voltage (I_R =250uA) | V _R | 1200 | V |
| Continuous Forward Current (Per leg/Device) $T_{C} = 25^{\circ}C$ $T_{C} = 135^{\circ}C$ $T_{C} = 159^{\circ}C$ | I _F | 31/62 16/32 10/20 | A |
| Non-Repetitive Forward Surge Current (Per leg) $T_c = 25^{\circ}C, t_p = 8.3 \text{ms}, \text{Half Sine Pulse}$ $T_c = 110^{\circ}C, t_p = 8.3 \text{ms}, \text{Half Sine Pulse}$ | I_{FSM} | 80 70 | A |
| Non-Repetitive Forward Surge Current (Per leg) $T_c = 25^{\circ}C, t_p = 8.3 \text{ms}, \text{Half Sine Pulse}$ $T_c = 110^{\circ}C, t_p = 8.3 \text{ms}, \text{Half Sine Pulse}$ | ∫ i ² dt | 27 20 | A ² s |
| Power dissipation (Per leg/Device) $T_{c} = 25^{\circ}C$ $T_{c} = 110^{\circ}C$ | P _{tot} | 115/230 50/100 | W |
| Operating junction Range | Tj | -55 to +175 | °C |
| Storage temperature Range | T _{stg} | -55 to +150 | °C |

Maximum Ratings (at Tc = 25 °C, unless otherwise specified)





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Thermal Resistance

| Parameter | Symbol | Max. | Unit |
|--------------------------------------|-------------------|----------------|------|
| Thermal resistance, junction – case. | R _{thJC} | 1.3* 0.65** | °C/W |

* Per leg, ** Device

Electrical Characteristic (Per leg at Tc = 25 °C, unless otherwise specified)

| Darameter | Symbol | Value | | | Unit | Test Condition | |
|-------------------------|----------------|-----------|------|--|------|---|--|
| Parameter | Symbol | min. | typ. | max. | Unit | Test Condition | |
| | | | | | | I _F =10A | |
| Forward Voltage | V _F | - | 1.4 | 1.7 | V | T _j =25°C | |
| | | - | 2 | - | | T _j =175°C | |
| | | | | | | V _R =1200V | |
| Reverse Current | I_R | - | 2 | 100 | μA | T _j =25°C | |
| | | - | 20 | - | | T _j =175°C | |
| Total Capacitive Charge | | | | | | V _R =800V, T _j =25℃ | |
| | Q _C | - 46 - nC | nC | $V_{R} = 800V, \ T_{j} = 25^{\circ}C$ $Q_{C} = \int_{0}^{V_{R}} C(V) dV$ | | | |
| Total Capacitance | | | | | | T _j =25℃, f=1MHz | |
| | С | - | 693 | - | ۶Ē | V _R =0V | |
| | Ľ | - | 45 | - | pF | V _R =400V | |
| | | - | 34 | - | | V _R =800V | |





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Characteristics Curve:

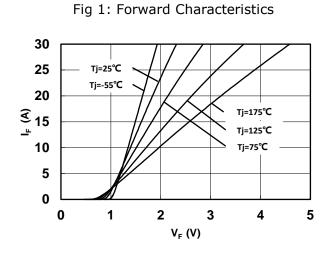


Fig 3: Current Derating

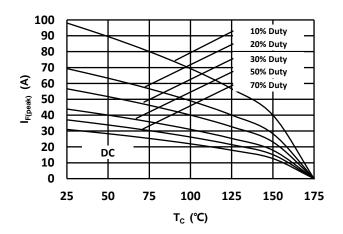


Fig 5: Capacitance vs. Reverse Voltage

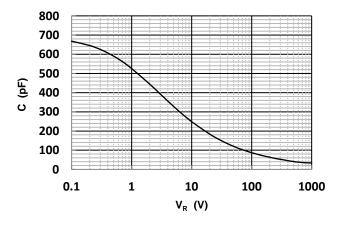
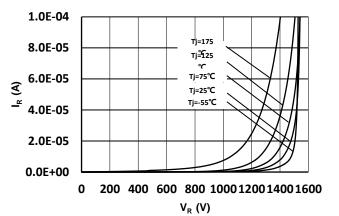
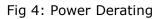


Fig 2: Reverse Characteristics





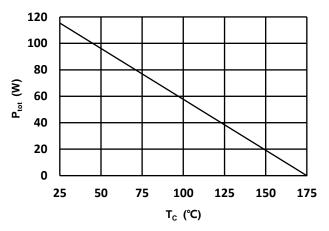
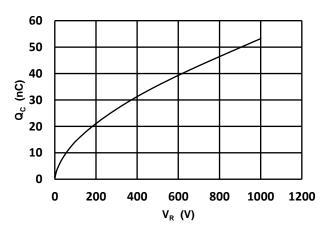


Fig 6: Reverse Charge vs. Reverse Voltage

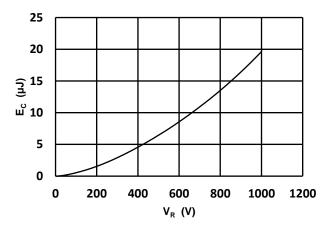




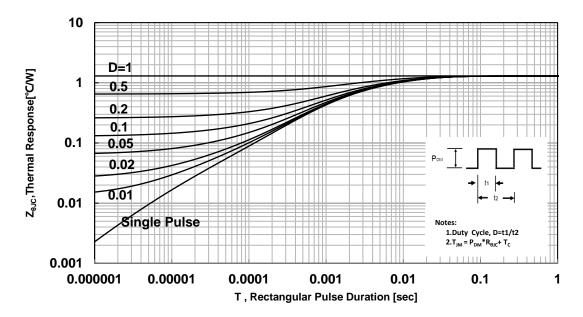


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Fig 7: Typical Capacitance Stored Energy





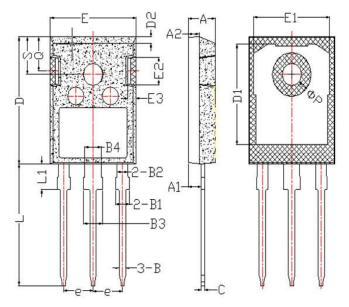






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Package Outline: TO-247



| Items | Values | s(mm) |
|-------|--------|-------|
| Items | MIN | MAX |
| A | 4.85 | 5.15 |
| A1 | 2.25 | 2.55 |
| A2 | 1.85 | 2.15 |
| В | 1.04 | 1.33 |
| B1 | 1.90 | 2.35 |
| B2 | 1.90 | 2.15 |
| B3 | 2.90 | 3.35 |
| B4 | 2.90 | 3.15 |
| С | 0.55 | 0.68 |
| D | 20.80 | 21.10 |
| D1 | 16.25 | 17.65 |
| D2 | 0.95 | 1.35 |
| E | 15.70 | 16.10 |
| E1 | 13.50 | 14.20 |
| E2 | 3.58 | 5.00 |
| E3 | 1.00 | 2.60 |
| е | 5. | 44 |
| L | 19.80 | 20.30 |
| L1 | 4.00 | 4.50 |
| Фр | 3.50 | 3.70 |
| Q | 5.40 | 6.00 |
| S | 6.00 | 6.40 |





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Revision History

| Revison | Date | Major changes |
|---------|------|----------------------------|
| 1.0 | | Release of formal version. |

Warnings

Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximun ratings of the device.

1. When installing the heatsink, please pay attention to the torsional moment and the smoothness of the heatsink.

2. This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control systems.



单击下面可查看定价,库存,交付和生命周期等信息

>>CRMICRO(华润微)